

# Distortion Correction using Beamer from GeniSys

*With Metrology on the Heidelberg DWLs*

A method to match lithography across different classes of tools

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# CNF – Open Access User Facility @ Cornell U

The image displays the website for the Cornell NanoScale Facility (CNF). The top left features the CNF logo with the text "Cornell NanoScale Science and Technology Facility". To the right is a search bar and the text "LAB USERS PORTAL". Below the logo is a navigation menu with links: "GETTING STARTED", "ABOUT US", "HIGHLIGHTS", "EDUCATION AND OUTREACH", "MEDIA", and "EQUIPMENT". A large banner below the menu shows a ruler with the text "Make it at the CNF" and a "10 μm" scale bar. To the right of the website screenshot is a grid of six buttons, each with an image and a label: "Start a New Project" (red button with a circular diagram), "Join an Existing Project" (orange button with a photo of people in a lab), "Remote Process Work" (teal button with a photo of a microchip), "Acknowledging CNF" (green button with a photo of people clapping), "Dress Code" (maroon button with a photo of a person in a cleanroom), and "Equipment" (blue button with a photo of lab equipment).

*Explore the broadest range of user scenarios on the toolset – Get the most out of the tools*

# Distortions in patterning systems

- Systems and Causes

- Optical lenses (LCD, Steppers)
- Electron beam columns
- **Galvo systems – Deflection-based systems**
- Nanoimprint
- Roll-to-roll

- Application and Motivation

- New materials ...
- ...allowed in etchers
- ...no recipe in RIE
- ... low ion mill rate

- Systematic -> Distortions (Reproducible)

- Path-ray non ideality (optical, magnetic..)
- Non-orthogonality, Magnification, Keystone
- Histeresis

- Stochastic -> Error (Non-reproducible)

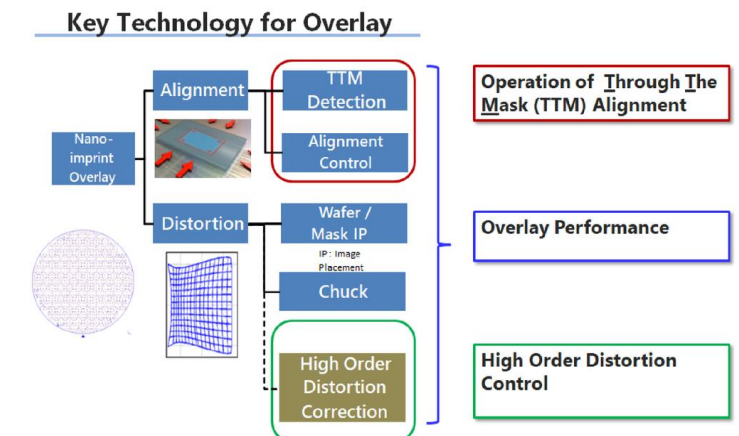
- Noise (EMI, vibration)
- Mechanical (e.g., backlash,etc..)
- Interference (e.g. sensors, ..)

- Environmental -> Drift (Measurable)

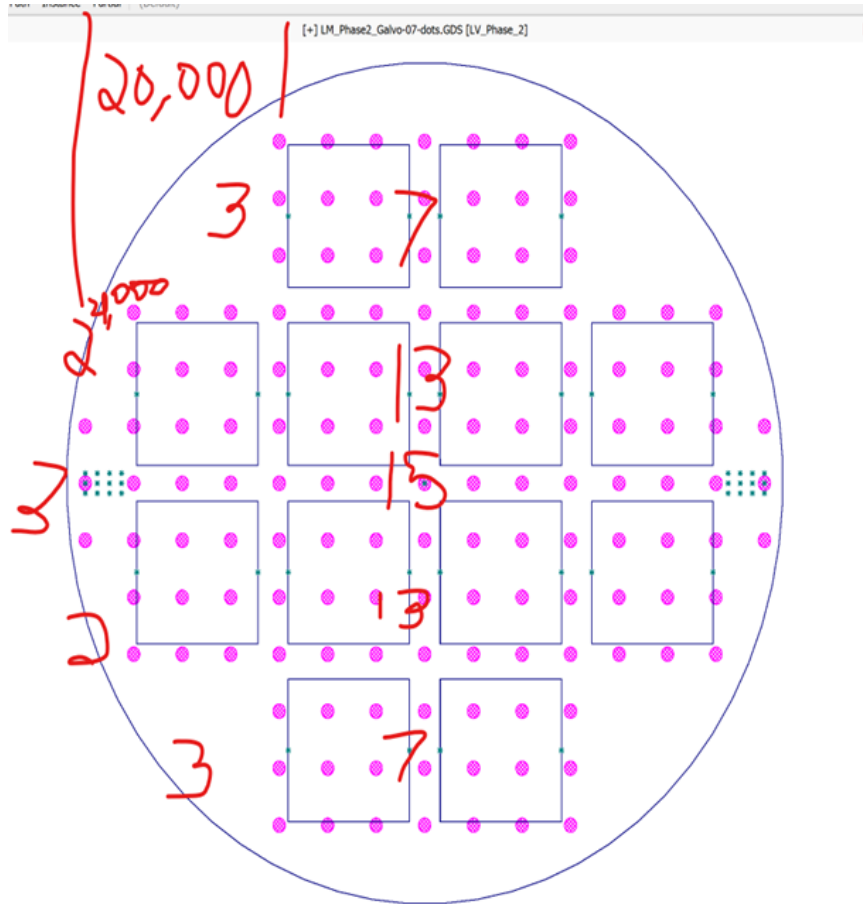
- Temperature
- Magnetic
- ...

- Material

- Bowing
- Stress
- ...



# The Problem: Pre-patterned high-value wafers

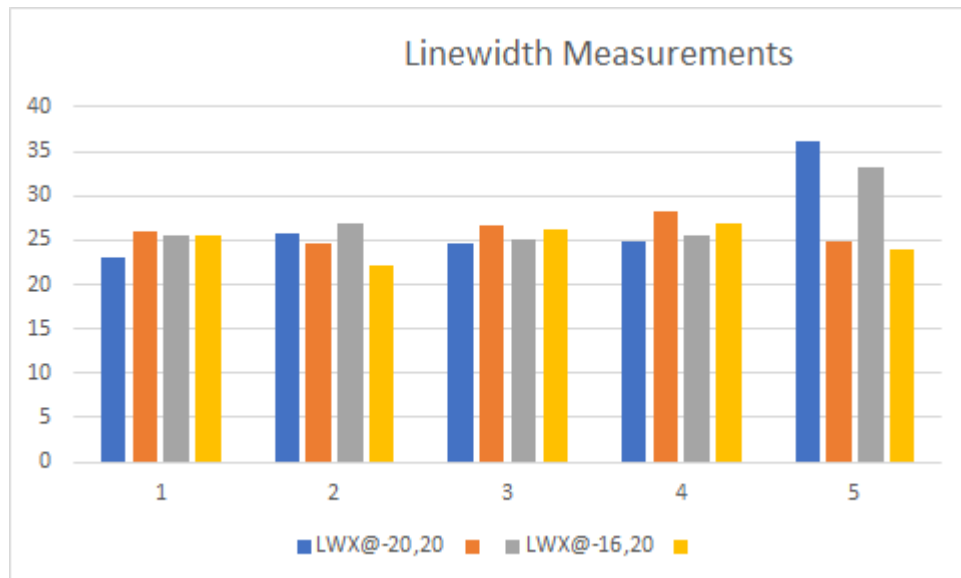


- Pre patterned Device Layer would not match photomask
  - Distortion was present
- GeniSys has Distortion Correction Module
- Heidelberg DWL metrology
- Solution -> Distort GDS to match distorted device (milestone need)

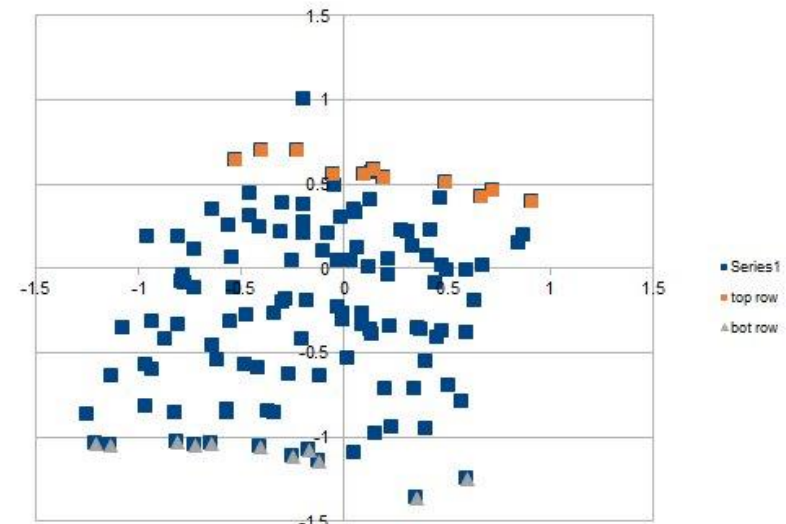
# Heidelberg DWL66 Metrology

- Measure routines
- Location, Linewidth, Overlay
- Die-by-Die or Routine
- Parameter optimization
  - Field Alignment Method

- **Scatter of “as-measured” data**
- **Rotated data (numerical processing)**



Gold Mask – Reference (DWL2000)



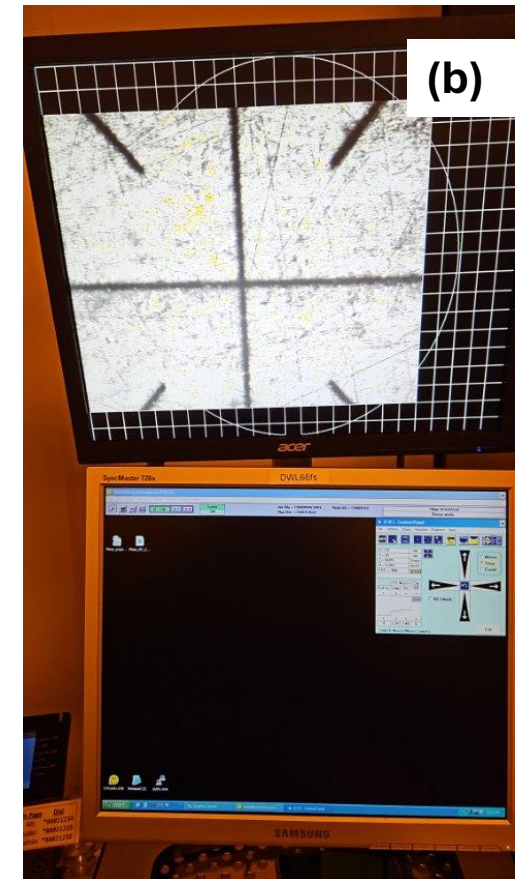
# Heidelberg DWL Mark Location

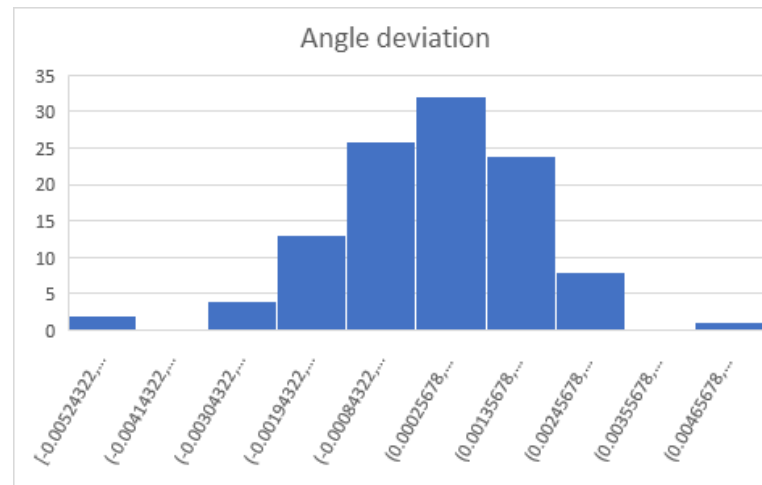
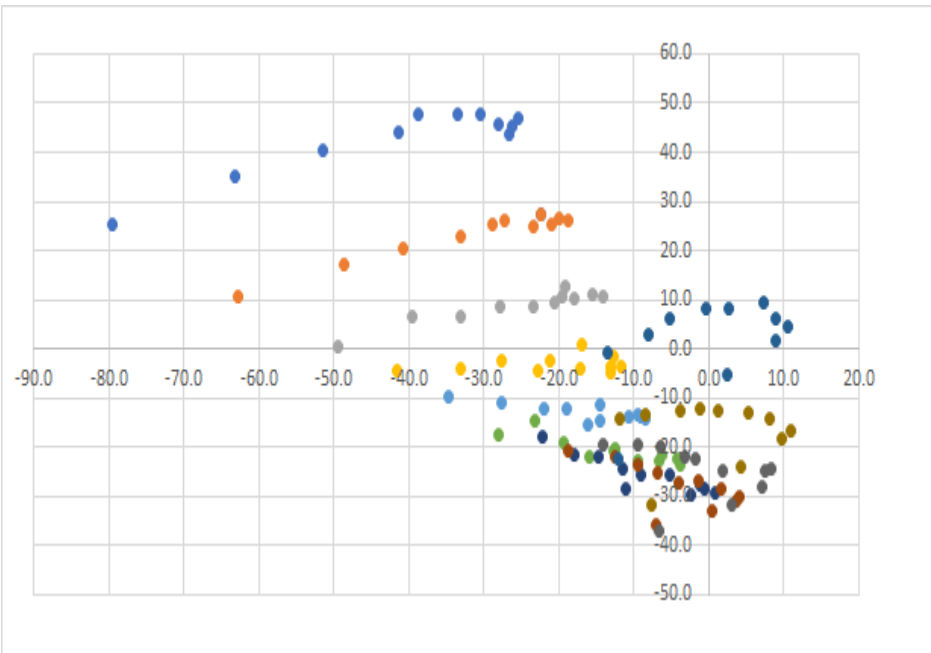
- Video system metrology
- Calibration with interferometric stage
- Dual camera system (micro and macro)
- Detect
  - Cross, Pattern, Lines
- Measure
  - Position, Linewidth
  - Overlay (box-in-box)

- On these wafers, reproducibility was  $\pm 0.5\mu\text{m}$

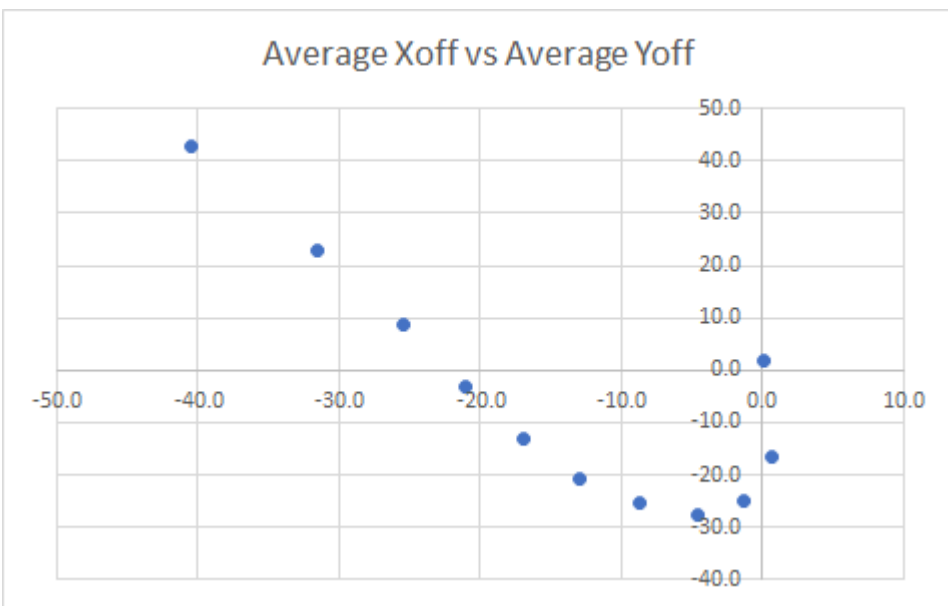


*(a) lower limb measured in red box – Micro camera;  
(b) Macro view of center cross and DWL66 control*





- Translation:  $\begin{pmatrix} x' \\ y' \end{pmatrix} = \begin{pmatrix} x \\ y \end{pmatrix} + \begin{pmatrix} tx \\ ty \end{pmatrix}$
- Rotation:  $\begin{pmatrix} x' \\ y' \end{pmatrix} = \begin{pmatrix} \cos(\theta) & -\sin(\theta) \\ \sin(\theta) & \cos(\theta) \end{pmatrix} * \begin{pmatrix} x \\ y \end{pmatrix}$
- Scaling:  $\begin{pmatrix} x' \\ y' \end{pmatrix} = \begin{pmatrix} Sx & 0 \\ 0 & Sy \end{pmatrix} * \begin{pmatrix} x \\ y \end{pmatrix}$



# Beamer – Pre-distortion of CAD

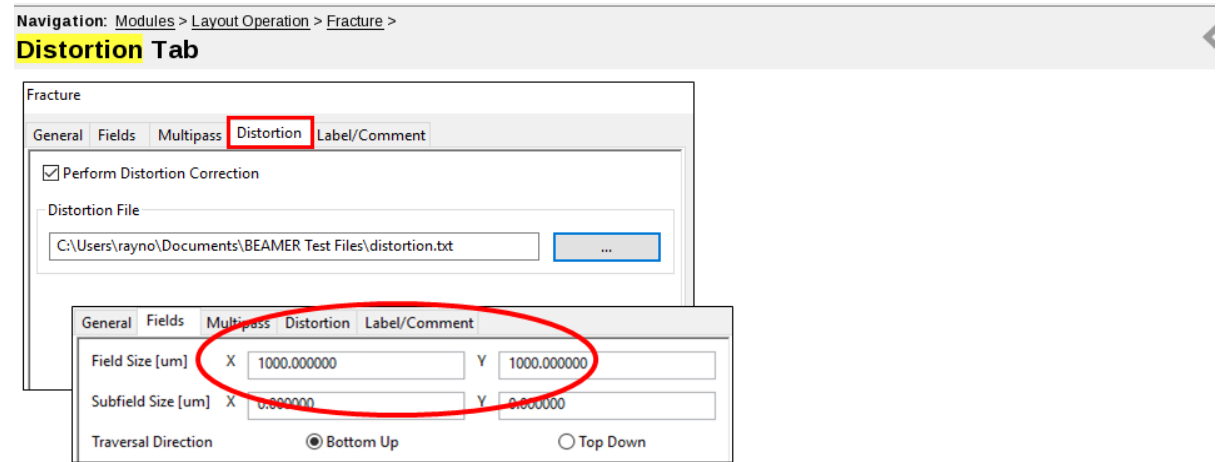
The screenshot shows the BEAMER software interface. The main window displays a workflow diagram for a file named 'dist\_FIXneg\_24x24.fxt'. The workflow starts with a root node 'distortion test' which branches into 'Extract' and 'Extract (1)'. 'Extract' leads to 'Distortion', which then leads to 'distortion\_sqrFIXneg24'. 'Extract (1)' leads to 'distortion\_test\_edit3a', which then leads to 'Merge'. 'Merge' leads to 'Extract (2)', which finally leads to 'distortion3\_test'. On the left side, there are two panels: 'Layout Operation' with buttons for Import, Export, Edit, Heal, Transform, Bias, AND, OR, MINUS, XOR, P-XOR, NOT, Extract, Replace, Merge, Grid, Mapping, Filter, Fracture, ChipPlace, and visual-Job; and 'Process Correction' with buttons for PEC, Shape-PEC, 3D-PEC, Corner-PEC, FDA, and Rule-OPC. The bottom status bar shows 'Converted Text Size: 1.000000 um'.

The screenshot shows the VIEWER software interface. The main window displays a grid layout with a red shape. The grid is composed of blue dots. The red shape is a small, irregular polygon. The interface includes a menu bar (File, View, E-Beam, Properties, Help), a toolbar with various icons, and a status bar at the bottom. The status bar shows 'mouse position (Layout Origin) [um]: -39852.5085; -1665.1143' and 'View Area [um]: -40583.534; -21808.936; 40641.552; 21890.161'. The bottom right corner shows a small thumbnail of the grid layout.

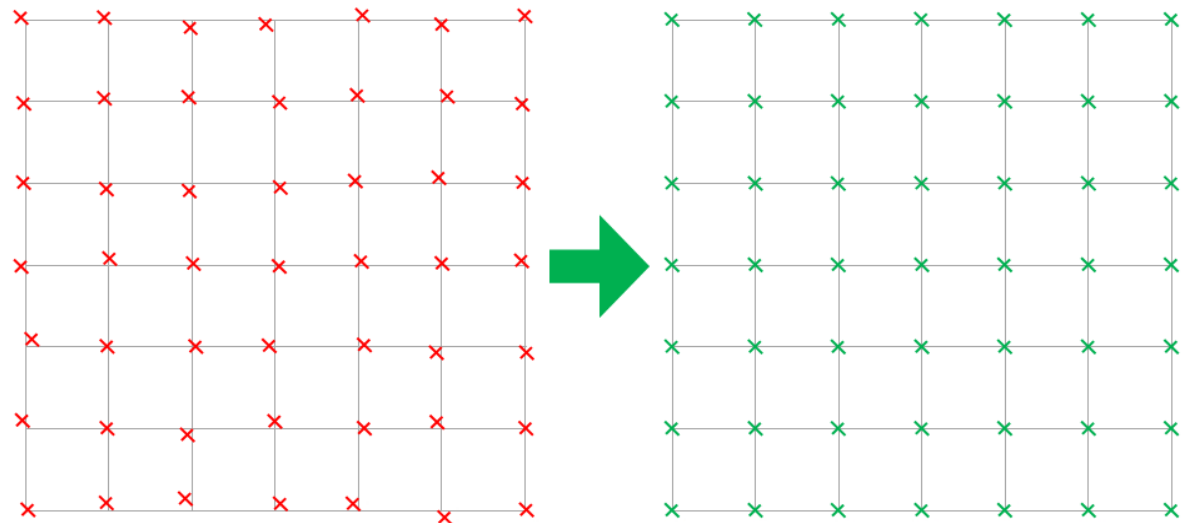


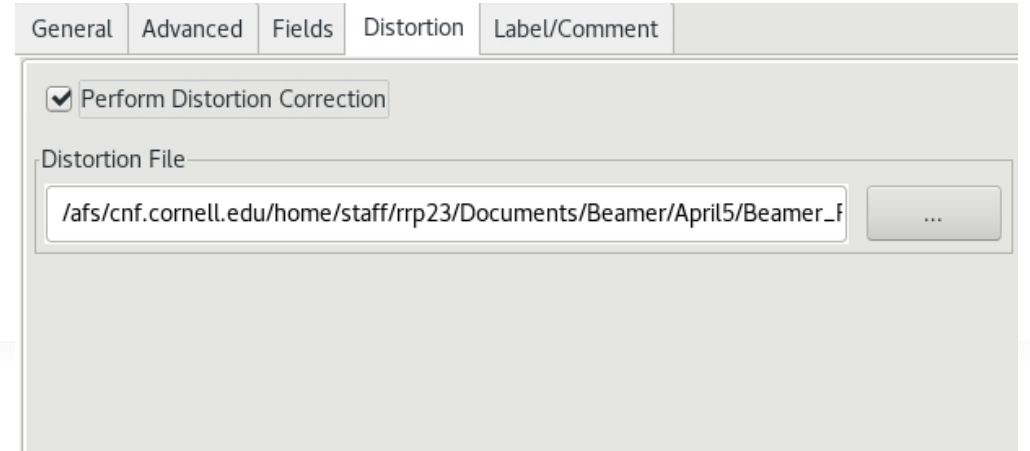
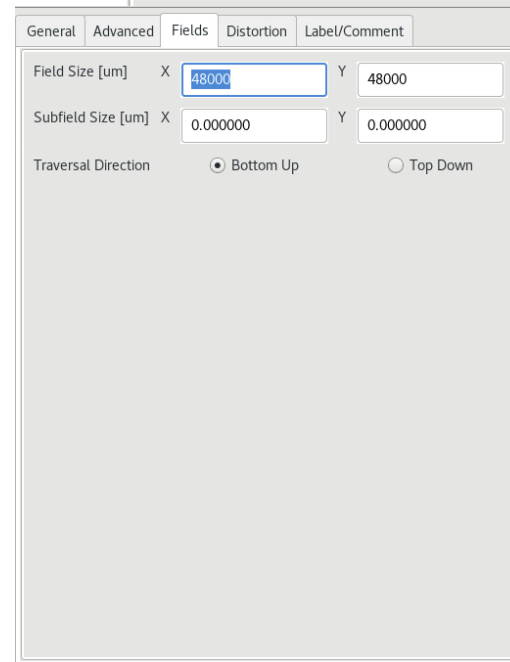
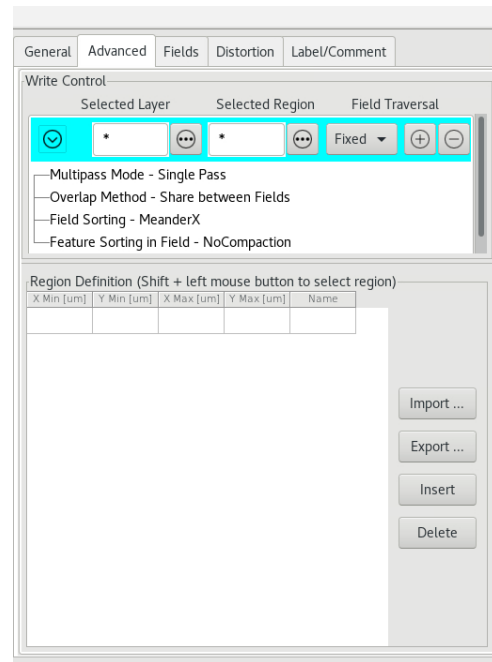
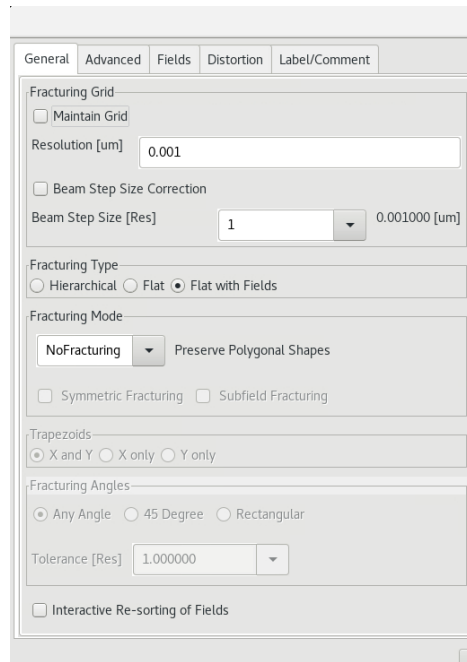
# GeniSys – Distortion Correction with Beamer

- Distortion correction will apply a position dependent correction of geometries in a pattern.
- Fracture module
  - ‘Flat with Fields’ option in the general tab.
  - Set the field size in the Fields tab to match your final export.
  - A map of field distortions is applied as shown above, and based on this, the pattern edges are shifted to compensate for these distortions.
  - Currently the distortion file can only be imported but not displayed/edited.
  - The distortion file uses a pre-defined format.
  - The distortion correction shifts each vertex of a polygon according to the distortion map.



The Field **Distortion** Correction is used to correct for residual **distortion** errors in the deflection field.





VIEWER - Distortion (on korat.cnf.cornell.edu)

File View E-Beam Properties Help

90 or 45 degree Drawing Speed: 64x

Layer Tree Doses

- Distortion
- 1(0)

Field Root

Field 0001

All Hide Show

Cell Information Measurement Info Pick Data Info

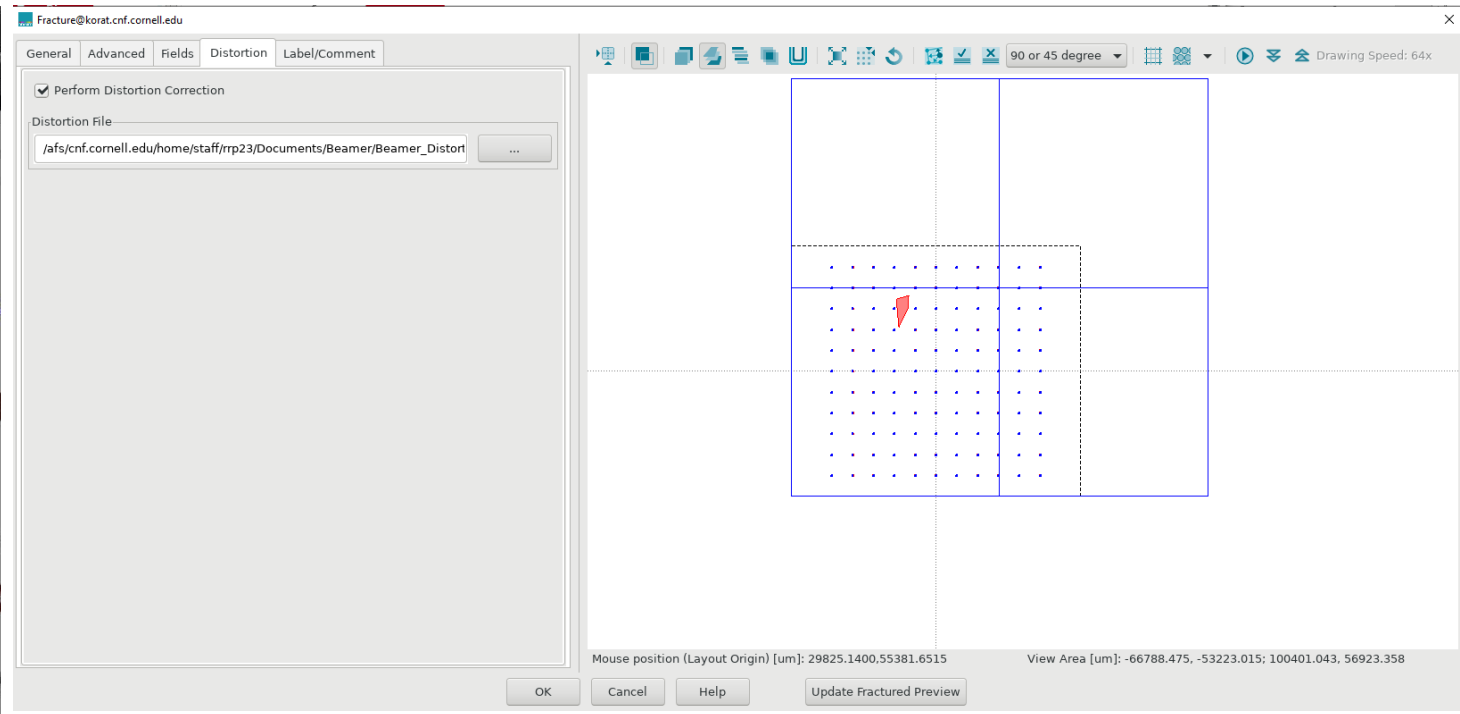
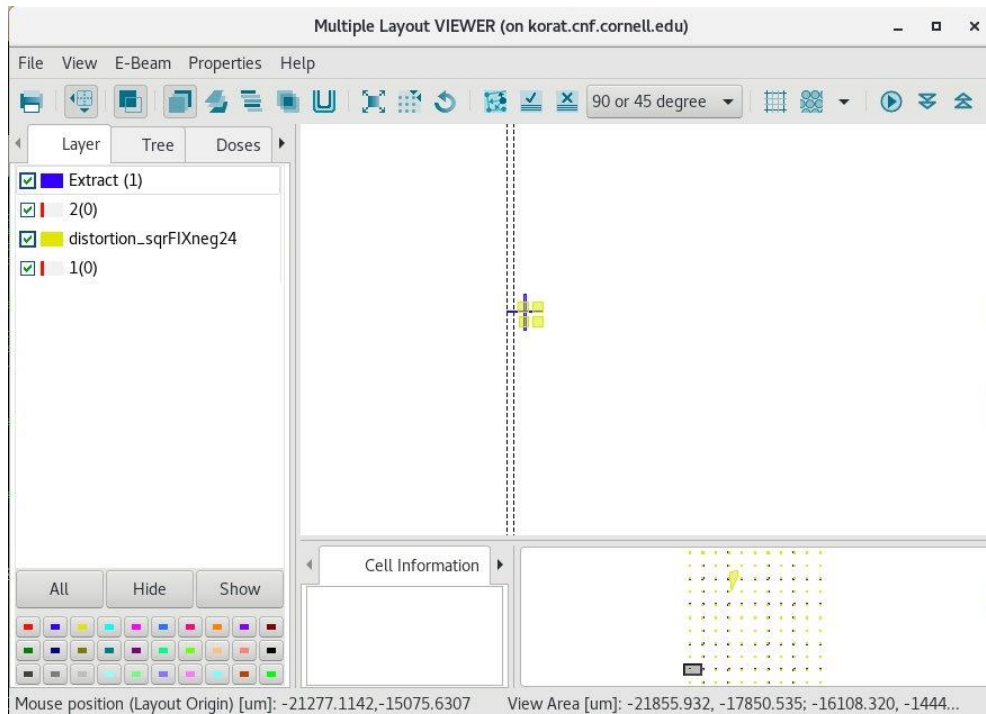
File Name:  
 Layout Bbox[um] : (-24000.000000, -24000.000000), (24000.000000,  
 Database Units [um] : 1.000000e-3

Field Root  
Field 0001

Mouse position (Layout Origin) [um]: -35820.4547,12233.5043 View Area [um]: -44660.724, -24020.530; 44724.223, 24109.826

# Beware of Mismatch in Field Size

-> Multiple fields used to Fracture -> **FAILURE!**



# Example Distortion File

BEAMER FRACTURE DISTORTION FILE v1.0

[FieldSize]

X=48000

Y=48000

[MeshSize]

X=4000

Y=4000

[DistortionVectors]

```
# @24000 @-20000 @-16000 @-12000 @-8000 @-4000 @0 @4000 @8000 @12000 @16000 @20000 @-24000
@24000 (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0),
@20000 (0|0), (-10| 17), (-9| 21), (-2| 25), (0| 28), (7| 30), (7| 32), (10| 33), (14| 31), (11| 28), (1| 24), (-13| 14), (0|0),
...
@4000 (0|0), (-18| -4), (-12| 0), (-8| -0), (-4| -2), (-2| -2), (2| -2), (5| -2), (7| -1), (9| 0), (5| 0), (-4| 3), (0|0),
@0 (0|0), (-21| 5), (-15| 4), (-12| 3), (-7| 3), (-10| -5), (-1| 2), (1| 4), (4| 3), (7| 4), (3| 10), (-4| 13), (0|0),
.....
@-24000 (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0), (0|0),
```

```
=TRANPOSE(I51:I61)
```

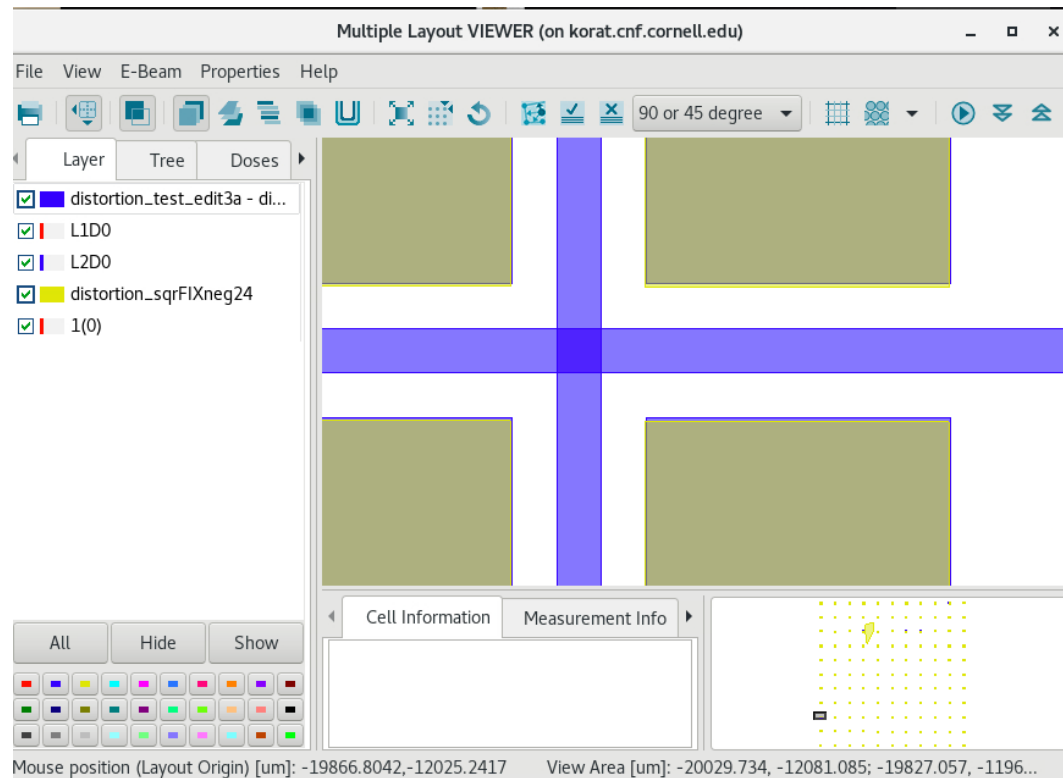
```
=ROUND(B2,0)&"| "&ROUND(B15,0)
=INT(B2)&"| "&INT(B15)
```

```
=CONCAT("(","O2,"")",",")"
```

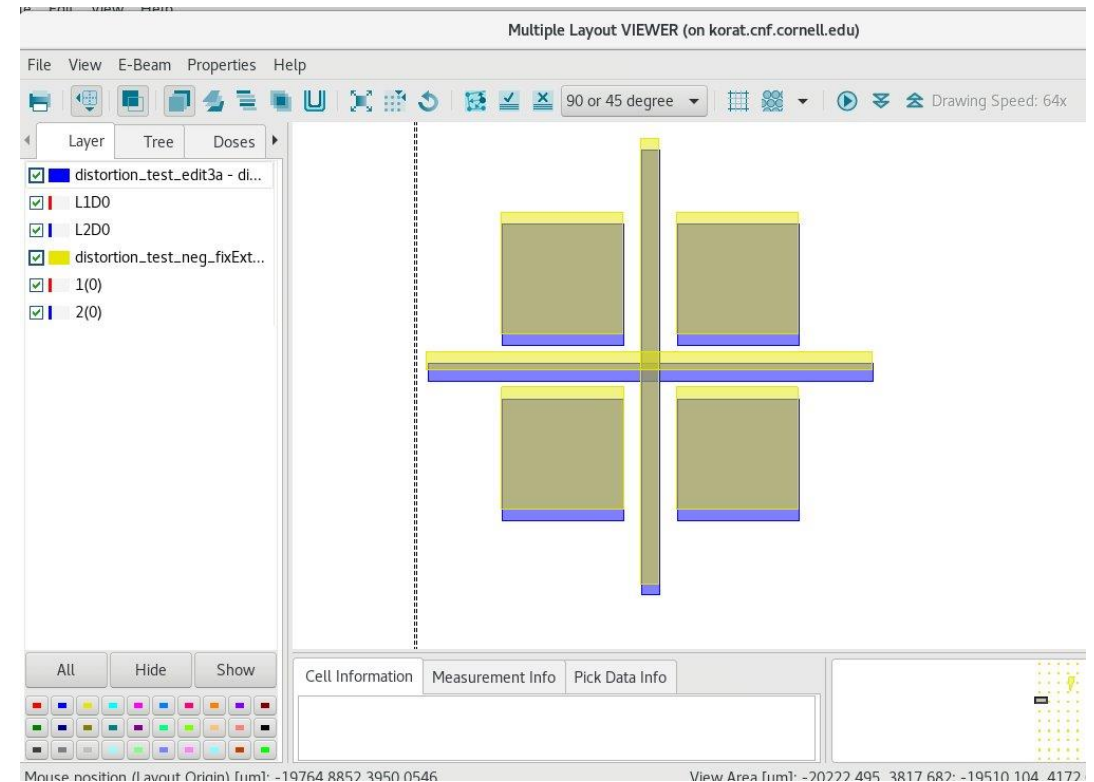
# Validate with measured data

## *Create CIF from Actual Locations*

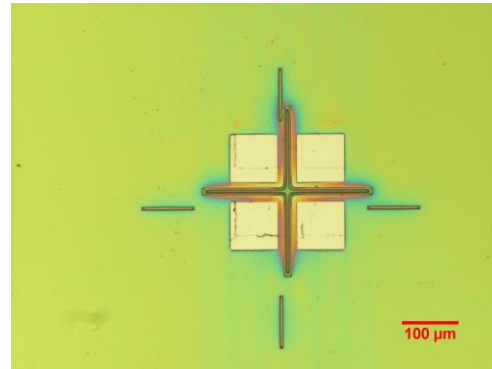
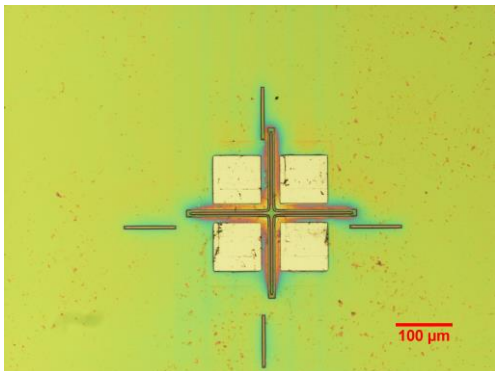
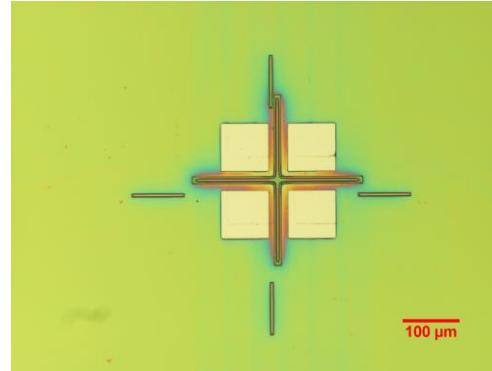
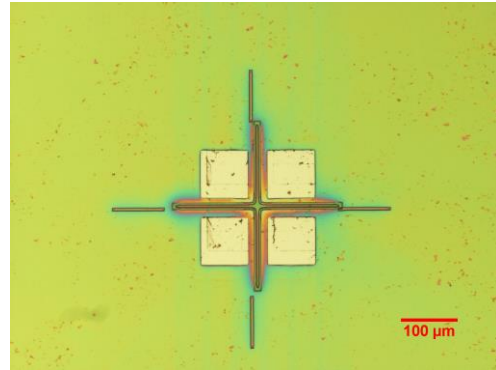
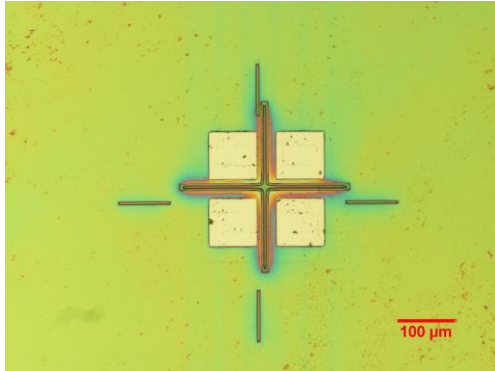
### Distortion Matrix matches Measurement



### Glitch in Transposing Measurements



# Distortion Corrected Exposure results



- Alignment of squares to cross field
- Crosses from measured data
- Squares from converted ideal pattern with Beamer
- Note
  - Extra limbs show problem with Distortion Matrix generation

# Summary and Recommendations

- Beamer Distortion Correction applied to large distortions successfully
- Interpolation is linear
- Distortion Matrix format is text format – easily assembled
- Can create mathematical interpolations using any distortion model
- Ability to distort pure paths is highly desirable
  - Had to convert to polygon
  - Preserve cell hierarchy (e.g. box-in-box)
- Import, Create, Manage
  - Distortion Matrices
  - Interaction with tools (DWL, ProSEM)
- For "developers",
  - Extraction of distortion type, and
  - Parametrization of model distortions



# Acknowledgements

- LUX
  - <https://www.luxsemiconductors.com>
- CNF
  - [cnf.cornell.edu/](http://cnf.cornell.edu/)
- NSF's NNCI
  - <https://cnf.cornell.edu/about/nnci>
- <https://www.nano.upenn.edu/>
  - <https://research.gatech.edu/node/19319>
- GeniSys
  - <https://www.genisys-gmbh.com>
- Heidelberg
  - DWL66 @ CNF
  - <https://www.cnfusers.cornell.edu/node/39>
- <https://research.gatech.edu/>
  - <https://www.nano.upenn.edu/equipment/ipg-photonics-ix200f-2/>



National Nanotechnology  
Coordinated Infrastructure